

### **Wire Wound SMD Power Inductor**

#### **◆** Features

- 1. Magnetic-resin shielded construction reduces buzz noise to ultra-low levels:
- 2. Metallization on ferrite core results in excellent shock resistance and damage-free durability;
- Closed magnetic circuit design reduces leakage flux and Electro Magnetic Interference (EMI);
- 4、30% higher current rating than conventional inductors of equal size;
- 5. Take up less PCB real estate and save more power.





## Applications

- 1. LED Lighting;
- 2 Mobile devices with multifunction such as adding color TV and camera;
- 3. Flat-screen TVs, blue-ray disc recorders, set top boxes;
- 4. Notebooks, desktop computers, servers, graphic cards;
- 5. Portable gaming devices, personal navigation systems, personal multimedia devices;
- 6. Automotive systems
- 7. Telecomm base stations

### Applications

# ◆ Lead Free Part Numbering

CMLW 5020 S 100 M S T (1) (2) (3) (4) (5) (6) (7)

(1) Series Type

(2) Dimension: LXH

(3) Material Code

(4) Inductance: 2R2=2.2μH;

100=10μH; 101=100μH

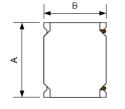
(5) Inductance Tolerance: M=±20%, N=±30%

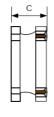
(6) Company Code

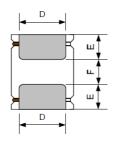
(7) Packaging: Tape Carrier Package

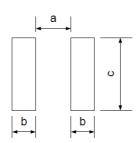
#### Dimensions

## Recommended Land Pattern









Unit:mm

Series	A	В	С	D	E	F	а Тур.	b Typ.	с Тур.
CMLW5020S	5.0±0.2	5.0±0.2	2.0Max.	4.0±0.2	1.25±0.2	2.50±0.2	2.1	1.5	4.4

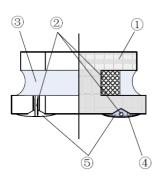
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## Electrical Characteristics

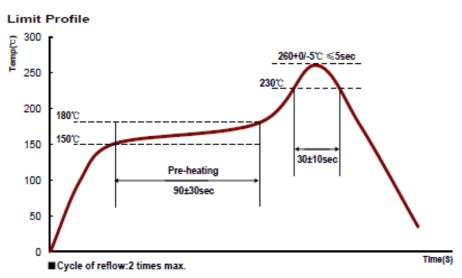
- 1) Operating temperature range (Including self-heating):  $-40^{\circ}$ C ~ +125 $^{\circ}$ C
- 2) Storage temperature range (packaging conditions): -10 °C ~+40 °C and RH 70% (Max.)

### Construction and material

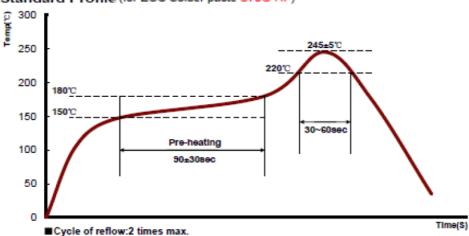


Code	Part Name	Material Name				
1	Ferrite Core	Ni-Zn Ferrite				
2	Wire	Polyurethane system enameled copper wire				
3	Magnteic Glue	Epoxy resin and magnetic powder				
		Ag				
4	Plating Electrodes	Ni				
		Sn				
(5)	Outer Electrodes	Top surface solder coating Sn 、Ag、Cu				

### **◆** REFLOW-PROFILE







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## **♦** Specification

Part Number	Inductance @100KHz,1V	DC Resistance ±20% (Ω)	Min.Self-resonant Frequency (MHz)	Saturation Current(A)	Heat Rating Current (A)	
	(µH)	DCR	S.R.F	Isat	Irms	
CMLW5020S Series						
CMLW5020SR47NST	0.47±30%	0.013	160	6.15	4.60	
CMLW5020SR68NST	0.68±30%	0.017	120	5.50	4.00	
CMLW5020S1R0MST	1.0±20%	0.020	97	4.33	3.70	
CMLW5020S1R5MST	1.5±20%	0.026	80	3.85	3.20	
CMLW5020S2R2MST	2.2±20%	0.035	61	3.85	2.90	
CMLW5020S3R3MST	3.3±20%	0.044	46	3.25	2.40	
CMLW5020S4R7MST	4.7±20%	0.057	33	2.50	2.25	
CMLW5020S5R6MST	5.6±20%	0.064	33	2.30	2.05	
CMLW5020S6R8MST	6.8±20%	0.087	30	1.80	1.70	
CMLW5020S100MST	10±20%	0.110	24	1.79	1.50	
CMLW5020S150MST	15±20%	0.165	20	1.44	1.25	
CMLW5020S220MST	22±20%	0.235	16	1.18	1.05	
CMLW5020S330MST	33±20%	0.370	13	0.97	0.83	
CMLW5020S470MST	47±20%	0.525	11	0.81	0.70	
CMLW5020S680MST	68±20%	0.885	8.8	0.70	0.53	
CMLW5020S101MST	100±20%	1.060	7.6	0.57	0.49	

#### ◆ Note

- 1: All test data is referenced to 20°C ambient:
- 2: Rated current: Isat or Irms, whichever is smaller;
- 3: Isat: DC current at which the inductance drops approximate 30% from its value without current;
- 4: Irms: DC current that causes the temperature rise (△T =40°C) from 20°C ambient.

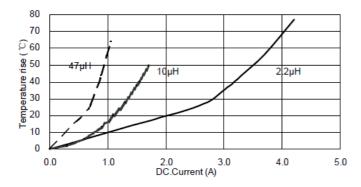
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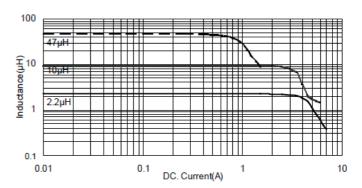
## **♦ TYPICAL ELECTRICAL CHARACTERISTICS**

#### CMLW5020S Series

## Temperature vs. DC Current Characteristics



### Inductance vs. DC Current Characteristics



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## ◆ Reliability Test

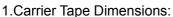
Items	Requirements	Test Methods and Remarks					
A. Terminal Strength	No removal or split of the termination or other defects shall occur.	1) Solder the inductor to the testing jig (glass eposition board shown in Fing.7.1-1) using eutectic solder. The apply a force in the direction of the arrow.  2) 10N force.  3) Keep time: 5±2s					
B. High Temperature	No visible mechanical damage.     Inductance change: Within ±10%	<ol> <li>Storage Temperature :125+/-5°C</li> <li>Duration : 96 ±4 Hours</li> <li>Recovery : then measured at room ambient temperature after placing 24 hours.</li> </ol>					
C. Low Temperature	No visible mechanical damage     Inductance change: Within ±10%	1) Temperature and time: -40±5°C  2) Duration: 96 <sup>±</sup> 4 hours  3) TRecovery: then measured at room ambient temperature after placing 24 hours.					
D. Vibration test	No visible mechanical damage.     Inductance change: Within ±10%	1) Frequency range:10HZ~55HZ~10HZ 2) Amplitude:1.5mm p-p 3) Direction:X,Y,Z 4) Time:1 minute/cycle,2hours per axis					
E. High Temperature Storage Tested	No visible mechanical damage.     Inductance change: Within ±10%	1) Storage Temperature :60+/-2°C 2) Relative Humidity :90-95% RH 3) Duration : 96 ±4 Hours 4) Recovery : then measured at room ambient temperature after placing 24 hours.					
F. Resistance to Soldering Heat	1. No visible mechanical damage. 2. Inductance change: Within ±10%  260°C  Peak 260°C  Max Ramp Up Rate=3°C/sec.  Max Ramp Down Rate=5°C/sec  60~120sec  Time 25°C to Peak =8 min max  Fig. 1	1) Re-flowing Profile: Please refer to Fig. 1 2) Test board thickness: 1.0mm 3) Test board material: glass epoxy resin 4) The chip shall be stabilized at normal condition for 1~2 hours before measuring					
G. Thermal Shock	1. No visible mechanical damage. 2. Inductance change: Within ±10%  105°C 30 min.  Ambient Temperature  40°C  Max 3 minute  Fig. 2	Temperature and time: -40±3°C for 30±3 min→105°C for 30±3min, please refer to Fig. 2.     Transforming interval: Max, 3 minute     Tested cycle: 100 cycles     The chip shall be stabilized at normal condition for 1~2 hours before measuring					

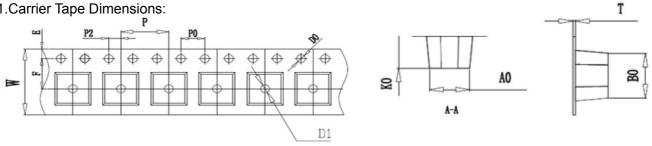
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B-B

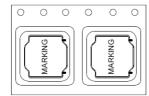
## **◆Packaging and Marking:**



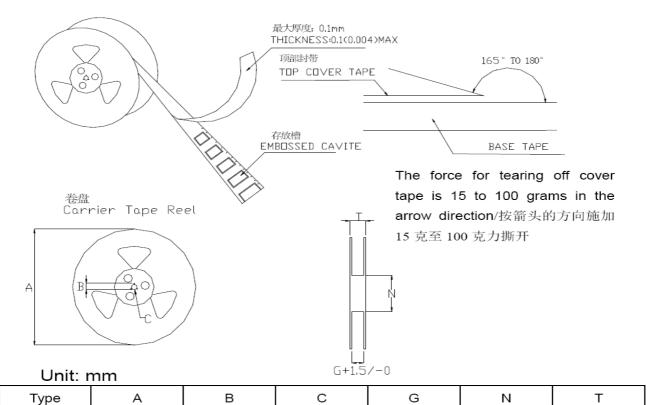


ITEM	W	A0	В0	K0	P	F	E	D0	PO	P2	T
DIM	12.00	5.4	5.4	2.2	8.00	5.50	1.75	1.50	4.00	2.00	0.35
TOLE	±0.3	±0.1	±0.1	±0.1	±0.1	±0.15	±0.1	+0.1	±0.1	±0.1	±0.05

#### 2. Taping Dimensions:



#### 3.Reel Dimensions:



#### 4. Packaging Quantity:

12mm

Standard Packing Quantity: 2500 pcs/reel Or 3000 pcs/reel

21±0.8

330

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13±0.4

12.4

100

16.4